



Typical Applications

The HMC741ST89E is ideal for:

- Cellular/3G & WiMAX/4G
- Fixed Wireless & WLAN
- CATV, Cable Modem & DBS
- Microwave Radio & Test Equipment
- IF & RF Applications

P1dB Output Power: +18.5 dBm

Features

Gain: 20 dB Output IP3: +42 dBm Cascadable 50 Ohm I/Os Single Supply: +5V Industry Standard SOT89 Package Robust 1000V ESD, Class 1C Stable Current Over Temperature Active Bias Network

General Description

The HMC741ST89E is an InGaP Heterojunction Bipolar Transistor (HBT) Gain Block MMIC SMT amplifier covering 0.05 to 3 GHz. Packaged in an industry standard SOT89, the amplifier can be used as a cascadable 50 Ohm RF or IF gain stage as well as a PA or LO driver with up to +18.5 dBm output power. The HMC741ST89E offers 20 dB of gain with a +42 dBm output IP3 at 200 MHz, and can operate directly from a +5V supply. The HMC741ST89E exhibits excellent gain and output power stability over temperature, while requiring a minimal number of external bias components.

HMC741ST89E

InGaP HBT ACTIVE BIAS

MMIC AMPLIFIER, 0.05 – 3 GHz

Functi	onal Dia	agram	
		GND	_
		4	
	1 IN	2 GND	3 OUT

Electrical Specifications, Vcc = 5V, T_{A} = +25° C

Parameter	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Frequency Range	150		240		50 - 1000		50 - 3000			MHz			
Gain	19	20		19	21		16	20		12	19		dB
Gain Flatness		±0.3			±0.3			±0.3			±2.6		dB
Gain Variation over Temperature		0.004			0.004			0.004	0.01		0.004	0.01	dB/ °C
Input Return Loss		16			16			16			12		dB
Output Return Loss		17			17			17			12		dB
Reverse Isolation		25			25			25			26		dB
Output Power for 1 dB Compression (P1dB)	16	18.8		16	18.8		16	18.8		14	16		dBm
Output Third Order Intercept (IP3) (Pout= 0 dBm per tone, 1 MHz spacing)		40.5			40.5			40.5			30		dBm
Noise Figure		2.5			2.5			2.5			2.5		dB
Supply Current (Icq)		96			96			96			96		mA

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EARTH FRIENDLY IF Band Performance

Gain & Return Loss



Noise Figure vs. Temperature



Output IP3 vs. Vcc



HMC741ST89E

InGaP HBT ACTIVE BIAS MMIC AMPLIFIER, 0.05 – 3 GHz

Gain vs. Temperature



Output IP3 vs. Temperature



Output IP3 vs. Output Power



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HMC741ST89E

InGaP HBT ACTIVE BIAS MMIC AMPLIFIER, 0.05 – 3 GHz



Broadband Performance

Gain & Return Loss



Gain vs. Vcc



Output Return Loss vs. Temperature



Gain vs. Temperature



Input Return Loss vs. Temperature



Input Return Loss vs. Vcc



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Output Return Loss vs. Vcc



Noise Figure vs. Vcc



Reverse Isolation vs. Vcc



InGaP HBT ACTIVE BIAS MMIC AMPLIFIER, 0.05 – 3 GHz

Noise Figure vs. Temperature



Reverse Isolation vs. Temperature



Output IP3 vs. Temperature



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InGaP HBT ACTIVE BIAS

MMIC AMPLIFIER, 0.05 - 3 GHz

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Output IP3 vs. Vcc



P1dB vs. Temperature



Power Compression @ 500 MHz



Current vs. Temperature



Psat vs. Temperature



Power Compression @ 2 GHz



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Absolute Maximum Ratings

Collector Bias Voltage (Vcc)	+5.5 Vdc		
RF Input Power (RFIN)	+15 dBm		
Junction Temperature	150 °C		
Continuous Pdiss (T = 85 °C) (derate 10.22 mW/°C above 85 °C)	0.66 W		
Thermal Resistance (junction to lead)	97.83 °C/W		
Storage Temperature	-65 to +150 °C		
Operating Temperature	-40 to +85 °C		
ESD Sensitivity (HMB)	Class 1C		



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

MMIC AMPLIFIER, 0.05 - 3 GHz

HMC741ST89E

InGaP HBT ACTIVE BIAS

Outline Drawing







NOTES:

1. PACKAGE BODY MATERIAL:

MOLDING COMPOUND MP-180S OR EQUIVALENT.

2. LEAD MATERIAL: Cu w/ Ag SPOT PLATING.

3. LEAD PLATING: 100% MATTE TIN.

4. DIMENSIONS ARE IN INCHES [MILLIMETERS]

ADIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.

7. ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[1]
HMC741ST89E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	<u>H741</u> XXXX

[1] 4-Digit lot number XXXX

[2] Max peak reflow temperature of 260 °C

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InGaP HBT ACTIVE BIAS MMIC AMPLIFIER, 0.05 – 3 GHz



Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	IN	This pin is DC coupled. An off chip DC blocking capacitor is required.	
3	OUT	RF output and DC Bias (Vcc) for the output stage.	
2, 4	GND	These pins and package bottom must be connected to RF/DC ground.	

Application Circuit





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InGaP HBT ACTIVE BIAS MMIC AMPLIFIER, 0.05 – 3 GHz

Evaluation PCB



List of Materials for Evaluation PCB 124390 [1]

-			
Item	Description		
J1, J2	PCB Mount SMA Connector		
J3, J4	DC Pin		
C1, C2	470 pF Capacitor, 0402 Pkg.		
C3	100 pF Capacitor, 0402 Pkg.		
C4	1000 pF Capacitor, 0603 Pkg.		
C5	2.2 µF Capacitor Tantalum		
L1	820 nH Inductor, 0603 Pkg.		
U1	HMC741ST89E		
PCB [2]	119392 Evaluation PCB		

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: FR4

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and package bottom should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation board should be mounted to an appropriate heat sink. The evaluation circuit board shown is available from Hittite upon request.

8 AMPLIFIERS - DRIVER & GAIN BLOCK - SMT

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